

Parameter	Rating	Units
Load Voltage	60	V
Load Current	1	A <sub>rms</sub> / A <sub>DC</sub>
On-Resistance (max)	0.4	Ω

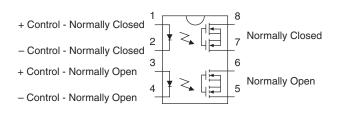
### **Features**

- 3750V<sub>rms</sub> Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 8-Pin Package
- · Machine Insertable, Wave Solderable
- Surface Mount Version
- Tape & Reel available

# **Applications**

- Telecommunications
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- · Utility Meters (gas, oil, electric and water)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

# **Pin Configuration**



### Description

LBA716 is a 60V, 1A,  $0.4\Omega$  dual Solid State Relay integrating independent normally open (1-Form-A) and normally closed (1-Form-B) relays into a single package. It features a superior combination of low on-resistance and enhanced peak load current (5A max.) handling capability.

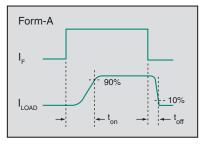
## **Approvals**

- UL Recognized Component: File # E76270
- CSA Certified Component: Certificate # 1175739
- EN/IEC 60950-1 Certified Component TUV Certificate B 09 07 49410 004

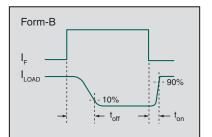
# **Ordering Information**

Part #	Description
LBA716	8-Pin DIP (50/Tube)
LBA716S	8-Pin Surface Mount (50/Tube)
LBA716STR	8-Pin Surface Mount (1000/Reel)

#### Switching Characteristics of Normally Open Devices



#### Switching Characteristics of Normally Closed Devices







# Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	60	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation <sup>1</sup>	150	mW
Total Power Dissipation <sup>2</sup>	800	mW
Isolation Voltage, Input to Output	3750	V <sub>rms</sub>
Operational Temperature	-40 to +85	C°
Storage Temperature	-40 to +125	О°

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

<sup>1</sup> Derate linearly 1.33 mW / °C

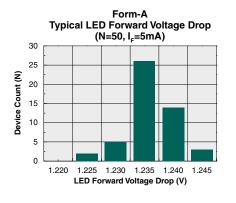
<sup>2</sup> Derate linearly 6.67 mW / °C

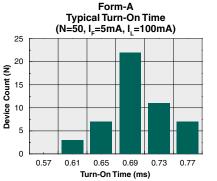
# **Electrical Characteristics @ 25°C**

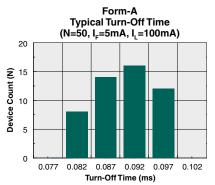
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Characteristics: Form-A (Normally C	Open)					
Load Current						
Continuous	-	١ <sub>L</sub>	-	-	1	$A_{\rm rms}/A_{\rm DC}$
Peak	t <u>&lt;</u> 10ms	I <sub>LPK</sub>	-	-	±5	Ap
On-Resistance	I <sub>L</sub> =1A	R <sub>ON</sub>	-	0.21	0.4	Ω
Off-State Leakage Current	V_=60V	ILEAK	-	-	1	μΑ
Output Capacitance	50V, f=1MHz	C <sub>OUT</sub>	-	105	-	pF
Switching Speeds						
Turn-On	L EmA \/ 10\/	t <sub>on</sub>	-	0.7	5	
Turn-Off	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>off</sub>	-	0.09	5	ms
Input Control Current to Activate	I <sub>L</sub> =1A	I <sub>F</sub>	-	-	2	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	-	-	mA
Characteristics: Form-B (Normally (	Closed)	· · · · ·				
Load Current						
Continuous	-	١	-	-	0.5	$A_{\rm rms}/A_{\rm DC}$
Peak	t <u>&lt;</u> 10ms	I <sub>LPK</sub>	-	-	±1.2	Ap
On-Resistance	I <sub>1</sub> =0.5A	R <sub>ON</sub>	-	1.63	2	Ω
Off-State Leakage Current	V <sub>1</sub> =60V, I <sub>F</sub> =5mA	ILEAK	-	-	1	μA
Output Capacitance	I <sub>F</sub> =5mA, 50V, f=1MHz	C <sub>OUT</sub>	-	280	-	pF
Switching Speeds						
Turn-On	L EmA \/ 10\/	t <sub>on</sub>	-	0.58	5	ms
Turn-Off	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>off</sub>	-	0.76	5	
Input Control Current to Activate	-	I <sub>F</sub>	-	-	2	mA
Input Control Current to Deactivate	I <sub>1</sub> =0.5A	I <sub>F</sub>	0.1	-	-	mA
Common Characteristics: Form-A a	nd Form-B			•	•	•
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>B</sub>	-	-	10	μΑ
Capacitance, Input to Output	-	C <sub>I/O</sub>	-	3	-	pF

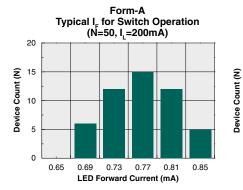
\*NOTE: If both poles operate simultaneously, then load current must be derated so as not to exceed the package power dissipation value.

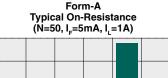
## Form-A RELAY PERFORMANCE DATA @25°C (Unless Otherwise Noted)\*











25

20

15

10

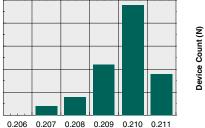
5

0

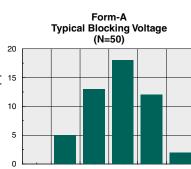
Turn-On Time (µs)

0

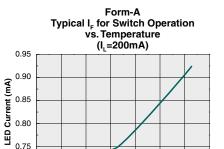
10



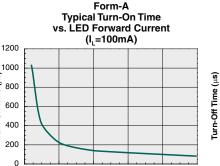
On-Resistance (Ω)







Temperature (°C)



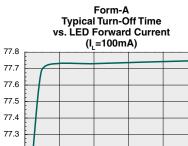
20

30

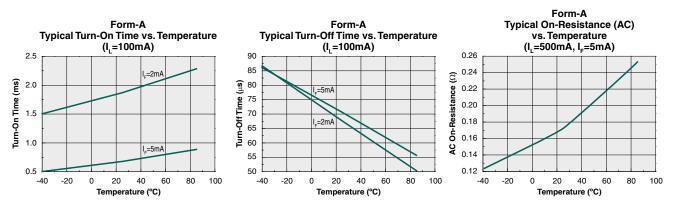
LED Forward Current (mA)

40

50







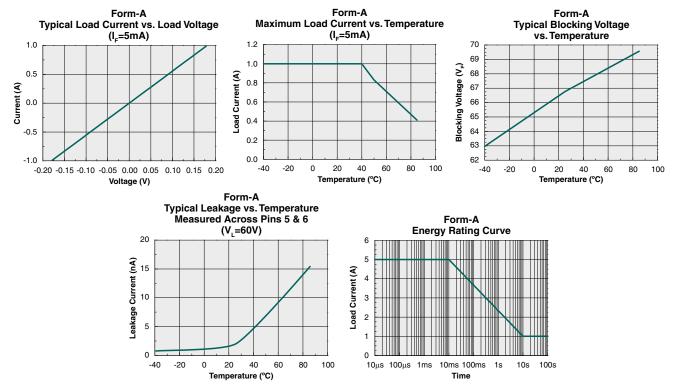
\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

0.70

-40

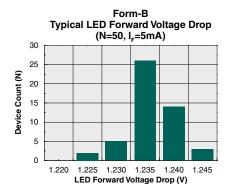
-20 0 20 40 60 80 100

# Form-A RELAY PERFORMANCE DATA @25°C (Unless Otherwise Noted)\*

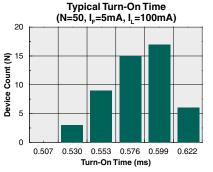


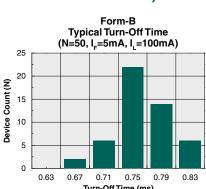
### Form-B RELAY PERFORMANCE DATA @25°C (Unless Otherwise Noted)\*

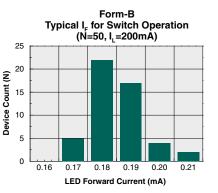
Form-B

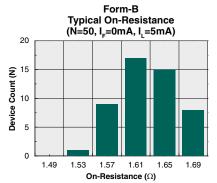


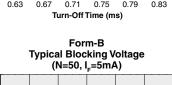
INTEGRATED CIRCUITS DIVISION

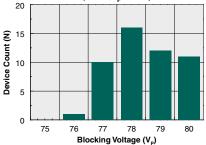






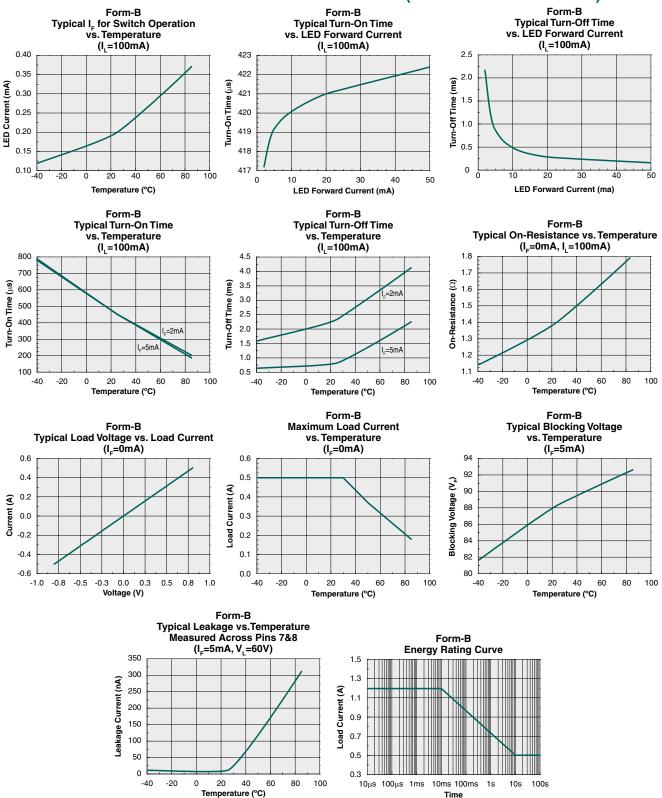






\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

### Form-B RELAY PERFORMANCE DATA @25°C (Unless Otherwise Noted)\*



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



# **Manufacturing Information**

#### **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating	
LBA716 / LBA716S	MSL 1	

#### **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

#### **Reflow Profile**

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
LBA716 / LBA716S	250°C for 30 seconds

#### **Board Wash**

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



R03



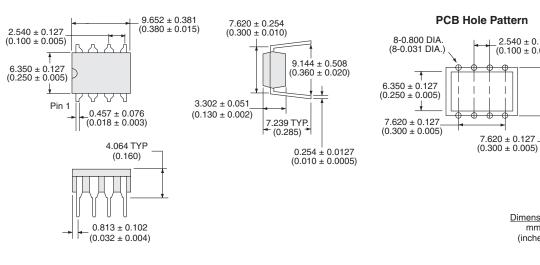
\_2.540 ± 0.127 (0.100 ± 0.005)

**Dimensions** 

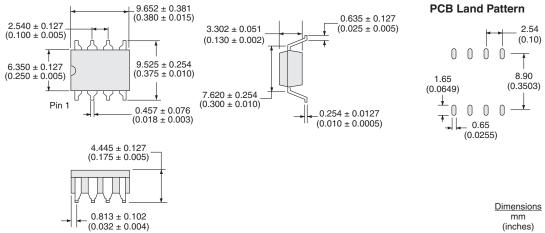
mm (inches)

# **Mechanical Dimensions**

### **LBA716**

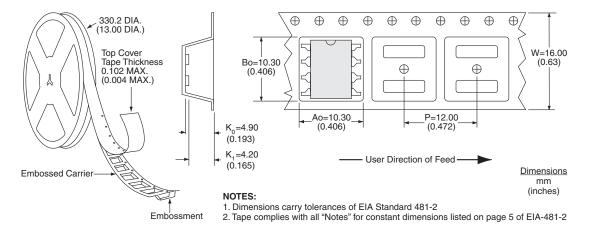


# **LBA716S**





# LBA716STR Tape & Reel



#### For additional information please visit our website at: www.ixysic.com

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